

## LM6164/LM6264/LM6364 High Speed Operational Amplifier

### General Description

The LM6164 family of high-speed amplifiers exhibits an excellent speed-power product in delivering 300V per  $\mu$ s and 175 MHz GBW (stable down to gains as low as +5) with only 5 mA of supply current. Further power savings and application convenience are possible by taking advantage of the wide dynamic range in operating supply voltage which extends all the way down to +5V.

These amplifiers are built with National's VIP™ (Vertically Integrated PNP) process which produces fast PNP transistors that are true complements to the already fast NPN devices. This advanced junction-isolated process delivers high speed performance without the need for complex and expensive dielectric isolation.

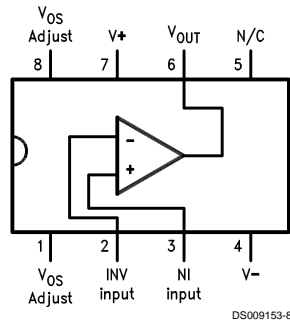
### Features

- High slew rate: 300 V/ $\mu$ s
- High GBW product: 175 MHz
- Low supply current: 5 mA
- Fast settling: 100 ns to 0.1%
- Low differential gain: <0.1%
- Low differential phase: <0.1°
- Wide supply range: 4.75V to 32V
- Stable with unlimited capacitive load

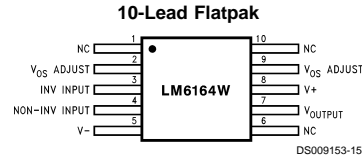
### Applications

- Video amplifier
- Wide-bandwidth signal conditioning
- Radar
- Sonar

### Connection Diagrams



**NS Package Number  
J08A, M08A or N08E**



**Top View  
NS Package Number W10A**

## Connection Diagrams (Continued)

Temperature Range			Package	NSC Drawing
Military -55°C ≤ T <sub>A</sub> ≤ +125°C	Industrial -25°C ≤ T <sub>A</sub> ≤ +85°C	Commercial 0°C ≤ T <sub>A</sub> ≤ +70°C		
	LM6264N	LM6364N	8-Pin Molded DIP	N08E
LM6164J/883 5962-8962401PA			8-Pin Ceramic DIP	J08A
		LM6364M	8-Pin Molded Surface Mt.	M08A
LM6164WG/883 5962-8962401XA			10-Lead Ceramic SOIC	WG10A
LM6164W/883 5962-8962401HA			10-Pin Ceramic Flatpak	W10A

## Absolute Maximum Ratings (Note 1)

If Military/Aerospace specified devices are required, please contact the National Semiconductor Sales Office/Distributors for availability and specifications.

Supply Voltage ( $V^+ - V^-$ )	36V
Differential Input Voltage (Note 7)	$\pm 8V$
Common-Mode Input Voltage (Note 11)	$(V^+ - 0.7V)$ to $(V^- + 0.7V)$
Output Short Circuit to Gnd (Note 2)	Continuous
Soldering Information	
Dual-In-Line Package (N, J)	
Soldering (10 sec.)	260°C
Small Outline Package (M)	
Vapor Phase (60 sec.)	215°C
Infrared (15 sec.)	220°C

See AN-450 "Surface Mounting Methods and Their Effect on Product Reliability" for other methods of soldering surface mount devices.

Storage Temperature Range	-65°C to +150°C
Max Junction Temperature (Note 3)	150°C
ESD Tolerance (Notes 7, 8)	$\pm 700V$

## Operating Ratings

Temperature Range (Note 3)	
LM6164	$-55^\circ C \leq T_J \leq +125^\circ C$
LM6264	$-25^\circ C \leq T_J \leq +85^\circ C$
LM6364	$0^\circ C \leq T_J \leq +70^\circ C$
Supply Voltage Range	4.75V to 32V

**Note 1:** "Absolute Maximum Ratings" indicate limits beyond which damage to the device may occur. Operating Ratings indicate conditions for which the device is functional, but do not guarantee specific performance limits.

## DC Electrical Characteristics

The following specifications apply for Supply Voltage =  $\pm 15V$ ,  $V_{CM} = 0$ ,  $R_L \geq 100\text{ k}\Omega$  and  $R_S = 50\Omega$  unless otherwise noted. **Boldface** limits apply for  $T_A = T_J = T_{MIN}$  to  $T_{MAX}$ ; all other limits  $T_A = T_J = 25^\circ C$ .

Symbol	Parameter	Conditions	Typ	LM6164	LM6264	LM6364	Units
				Limit (Notes 4, 12)	Limit (Note 4)	Limit (Note 4)	
$V_{OS}$	Input Offset Voltage		2	4	4	9	mV
				<b>6</b>	<b>6</b>	<b>11</b>	max
$V_{OS}$ Drift	Input Offset Voltage Average Drift		6				$\mu V/^\circ C$
$I_b$	Input Bias Current		2.5	3	3	5	$\mu A$
				<b>6</b>	<b>5</b>	<b>6</b>	max
$I_{OS}$	Input Offset Current		150	350	350	1500	nA
				<b>800</b>	<b>600</b>	<b>1900</b>	max
$I_{OS}$ Drift	Input Offset Current Average Drift		0.3				$nA/^\circ C$
$R_{IN}$	Input Resistance	Differential	100				k $\Omega$
$C_{IN}$	Input Capacitance		3.0				pF
$A_{VOL}$	Large Signal Voltage Gain	$V_{OUT} = \pm 10V$ , $R_L = 2\text{ k}\Omega$ (Note 10)	2.5	1.8	1.8	1.3	V/mV
		$R_L = 10\text{ k}\Omega$	9	<b>0.9</b>	<b>1.2</b>	<b>1.1</b>	min
$V_{CM}$	Input Common-Mode Voltage Range	Supply = $\pm 15V$	+14.0	+13.9	+13.9	+13.8	V
			<b>+13.8</b>	<b>+13.8</b>	<b>+13.7</b>	min	
		-13.5	-13.3	-13.3	-13.2	V	
		<b>-13.1</b>	<b>-13.1</b>	<b>-13.1</b>	min		
		Supply = +5V (Note 5)	4.0	3.9	3.9	3.8	V
			<b>3.8</b>	<b>3.8</b>	<b>3.7</b>	min	
			1.5	1.7	1.7	1.8	V
			<b>1.9</b>	<b>1.9</b>	<b>1.9</b>	max	
CMRR	Common-Mode Rejection Ratio	$-10V \leq V_{CM} \leq +10V$	105	86	86	80	dB
				<b>80</b>	<b>82</b>	<b>78</b>	min
PSRR	Power Supply Rejection Ratio	$\pm 10V \leq V_{\pm} \leq \pm 16V$	96	86	86	80	dB
				<b>80</b>	<b>82</b>	<b>78</b>	min

## DC Electrical Characteristics (Continued)

The following specifications apply for Supply Voltage =  $\pm 15\text{V}$ ,  $V_{\text{CM}} = 0$ ,  $R_{\text{L}} \geq 100\text{ k}\Omega$  and  $R_{\text{S}} = 50\Omega$  unless otherwise noted. **Boldface** limits apply for  $T_{\text{A}} = T_{\text{J}} = T_{\text{MIN}}$  to  $T_{\text{MAX}}$ ; all other limits  $T_{\text{A}} = T_{\text{J}} = 25^{\circ}\text{C}$ .

Symbol	Parameter	Conditions	Typ	LM6164	LM6264	LM6364	Units
				Limit (Notes 4, 12)	Limit (Note 4)	Limit (Note 4)	
$V_{\text{O}}$	Output Voltage Swing	Supply = +5V and $R_{\text{L}} = 2\text{ k}\Omega$	+14.2	+13.5 <b>+13.3</b>	+13.5 <b>+13.3</b>	+13.4 <b>+13.3</b>	V min
			-13.4	-13.0 <b>-12.7</b>	-13.0 <b>-12.8</b>	-12.9 <b>-12.8</b>	V min
		Supply = +5V and $R_{\text{L}} = 2\text{ k}\Omega$ (Note 10)	4.2	3.5 <b>3.3</b>	3.5 <b>3.3</b>	3.4 <b>3.3</b>	V min
			1.3	1.7 <b>2.0</b>	1.7 <b>1.9</b>	1.8 <b>1.9</b>	V max
	Output Short Circuit Current	Source	65	30 <b>20</b>	30 <b>25</b>	30 <b>25</b>	mA min
		Sink	65	30 <b>20</b>	30 <b>25</b>	30 <b>25</b>	mA min
$I_{\text{S}}$	Supply Current		5.0	6.5 <b>6.8</b>	6.5 <b>6.7</b>	6.8 <b>6.9</b>	mA min

## AC Electrical Characteristics

The following specifications apply for Supply Voltage =  $\pm 15\text{V}$ ,  $V_{\text{CM}} = 0$ ,  $R_{\text{L}} \geq 100\text{ k}\Omega$  and  $R_{\text{S}} = 50\Omega$  unless otherwise noted. **Boldface** limits apply for  $T_{\text{A}} = T_{\text{J}} = T_{\text{MIN}}$  to  $T_{\text{MAX}}$ ; all other limits  $T_{\text{A}} = T_{\text{J}} = 25^{\circ}\text{C}$ .

Symbol	Parameter	Conditions	Typ	LM6164	LM6264	LM6364	Units
				Limit (Notes 4, 12)	Limit (Note 4)	Limit (Note 4)	
GBW	Gain-Bandwidth Product	F = 20 MHz	175	140 <b>100</b>	140 <b>120</b>	120 <b>100</b>	MHz min
		Supply = $\pm 5\text{V}$	120				
SR	Slew Rate	$A_{\text{V}} = +5$ (Note 9)	300	200 <b>180</b>	200 <b>180</b>	200 <b>180</b>	V/ $\mu\text{s}$ min
		Supply = $\pm 5\text{V}$	200				
PBW	Power Bandwidth	$V_{\text{OUT}} = 20 V_{\text{PP}}$	4.5				MHz
$T_{\text{S}}$	Settling Time	10V Step to 0.1% $A_{\text{V}} = -4$ , $R_{\text{L}} = 2\text{ k}\Omega$	100				ns
$\phi_{\text{m}}$	Phase Margin	$A_{\text{V}} = +5$	45				Deg
$A_{\text{D}}$	Differential Gain	NTSC, $A_{\text{V}} = +10$	<0.1				%
$\phi_{\text{D}}$	Differential Phase	NTSC, $A_{\text{V}} = +10$	<0.1				Deg
$e_{\text{np-p}}$	Input Noise Voltage	F = 10 kHz	8				nV/ $\sqrt{\text{Hz}}$
$i_{\text{np-p}}$	Input Noise Current	F = 10 kHz	1.5				pA/ $\sqrt{\text{Hz}}$

**Note 2:** Continuous short-circuit operation at elevated ambient temperature can result in exceeding the maximum allowed junction temperature of  $150^{\circ}\text{C}$ .

**Note 3:** The typical junction-to-ambient thermal resistance of the molded plastic DIP (N) is  $105^{\circ}\text{C}/\text{Watt}$ , the molded plastic SO (M) package is  $155^{\circ}\text{C}/\text{Watt}$ , and the cerdip (J) package is  $125^{\circ}\text{C}/\text{Watt}$ . All numbers apply for packages soldered directly into a printed circuit board.

**Note 4:** Limits are guaranteed by testing or correlation.

**Note 5:** For single supply operation, the following conditions apply:  $V^{+} = 5\text{V}$ ,  $V^{-} = 0\text{V}$ ,  $V_{\text{CM}} = 2.5\text{V}$ ,  $V_{\text{OUT}} = 2.5\text{V}$ . Pin 1 & Pin 8 ( $V_{\text{OS}}$  Adjust) are each connected to Pin 4 ( $V^{-}$ ) to realize maximum output swing. This connection will degrade  $V_{\text{OS}}$ .

**Note 6:**  $C_{\text{L}} \leq 5\text{ pF}$ .

**Note 7:** In order to achieve optimum AC performance, the input stage was designed without protective clamps. Exceeding the maximum differential input voltage results in reverse breakdown of the base-emitter junction of one of the input transistors and probable degradation of the input parameters (especially  $V_{\text{OS}}$ ,  $I_{\text{OS}}$ , and Noise).

**Note 8:** The average voltage that the weakest pin combinations (those involving Pin 2 or Pin 3) can withstand and still conform to the datasheet limits. The test circuit used consists of the human body model of  $100\text{ pF}$  in series with  $1500\Omega$ .

## AC Electrical Characteristics (Continued)

**Note 9:**  $V_{IN} = 4V$  step. For supply =  $\pm 5V$ ,  $V_{IN} = 1V$  step.

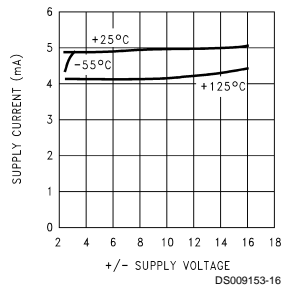
**Note 10:** Voltage Gain is the total output swing (20V) divided by the input signal required to produce that swing.

**Note 11:** The voltage between  $V^+$  and either input pin must not exceed 36V.

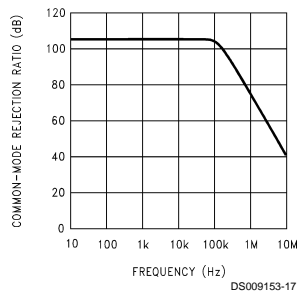
**Note 12:** A military RETS electrical test specification is available on request. At the time of printing, the LM6164J/883 RETS spec complied with the **Boldface** limits in this column. The LM6164J/883 may also be procured as Standard Military Drawing #5962-8962401PA.

## Typical Performance Characteristics ( $R_L = 10\text{ k}\Omega$ , $T_A = 25^\circ\text{C}$ unless otherwise specified)

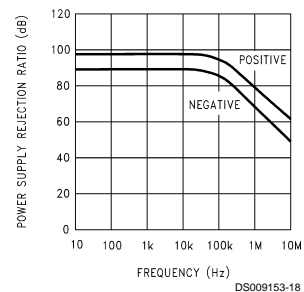
**Supply Current vs Supply Voltage**



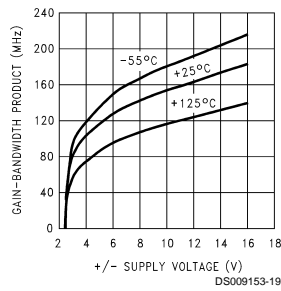
**Common-Mode Rejection Ratio**



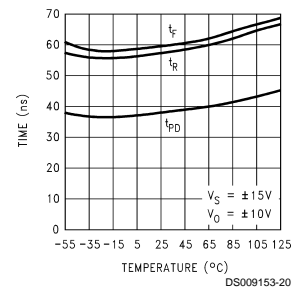
**Power Supply Rejection Ratio**



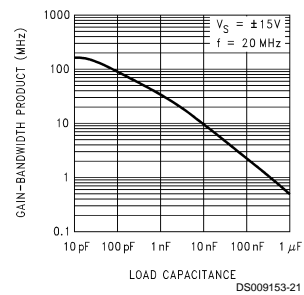
**Gain-Bandwidth Product**



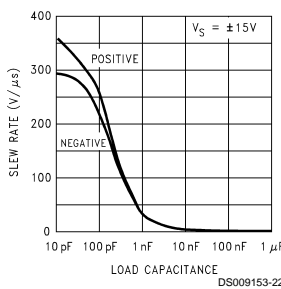
**Propagation Delay Rise and Fall Time**



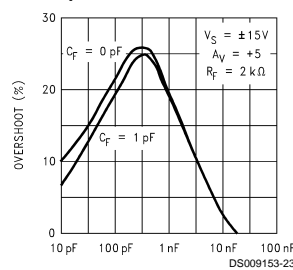
**Gain-Bandwidth Product vs Load Capacitance**



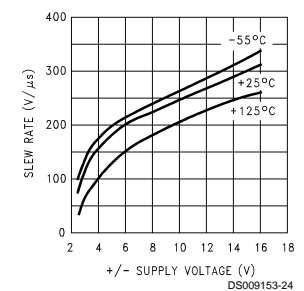
**Slew Rate vs Load Capacitance**



**Overshoot vs Load Capacitance**

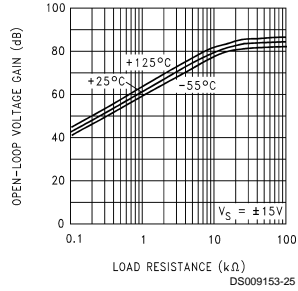


**Slew Rate**

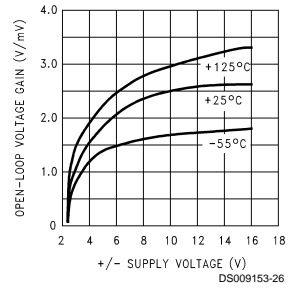


**Typical Performance Characteristics** ( $R_L = 10\text{ k}\Omega$ ,  $T_A = 25^\circ\text{C}$  unless otherwise specified) (Continued)

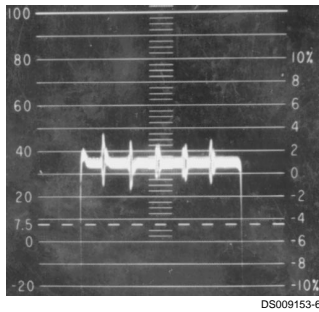
**Voltage Gain vs Load Resistance**



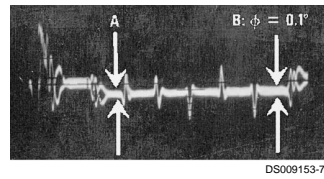
**Gain vs Supply Voltage**



**Differential Gain**  
(Note 13)

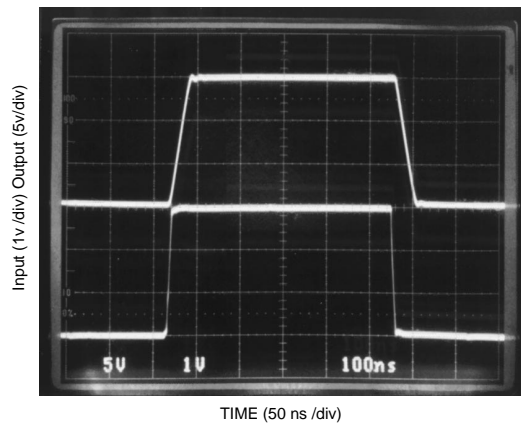


**Differential Phase**  
(Note 13)



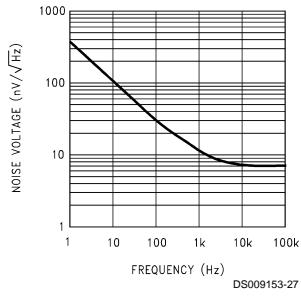
**Note 13:** Differential gain and differential phase measured for four series LM6364 op amps in series with an LM6321 buffer. Error added by LM6321 is negligible. Test performed using Tektronix Type 520 NTSC test system. Configured with a gain of +5 (each output attenuated by 80%)

**Step Response;  $A_v = +5$**

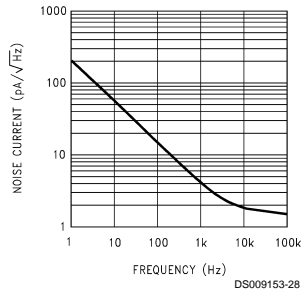


**Typical Performance Characteristics** ( $R_L = 10\text{ k}\Omega$ ,  $T_A = 25^\circ\text{C}$  unless otherwise specified) (Continued)

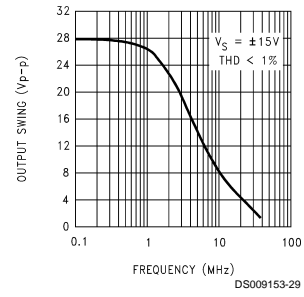
**Input Noise Voltage**



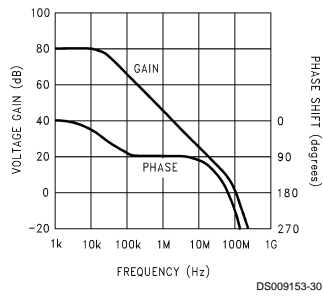
**Input Noise Current**



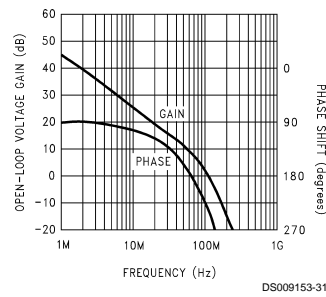
**Power Bandwidth**



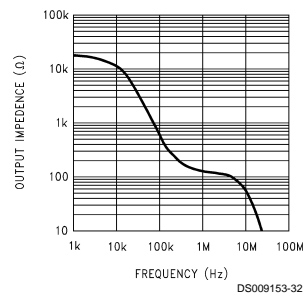
**Open-Loop Frequency Response**



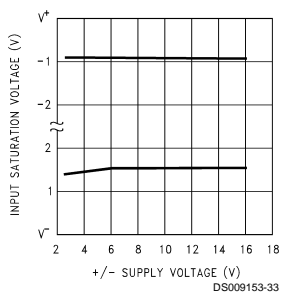
**Open-Loop Frequency Response**



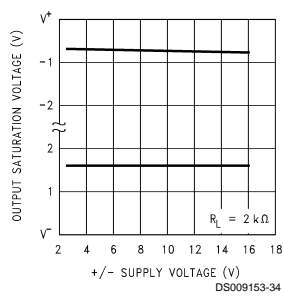
**Output Resistance Open-Loop**



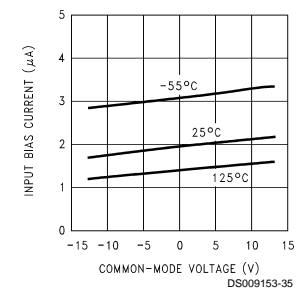
**Common-Mode Input Saturation Voltage**



**Output Saturation Voltage**



**Bias Current vs Common-Mode Voltage**

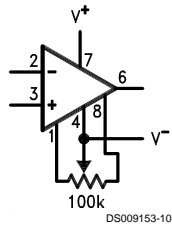




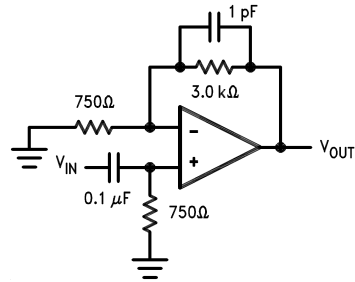


## Typical Applications

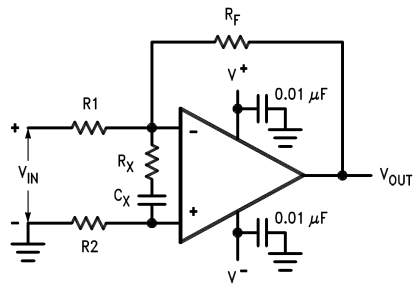
Offset Voltage Adjustment



Video-Bandwidth Amplifier



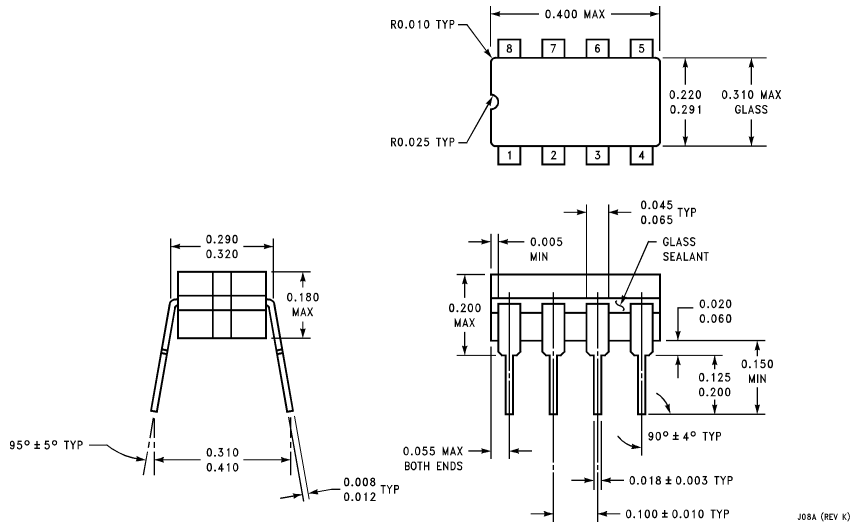
Noise-Gain Compensation for Gains  $\leq 5$



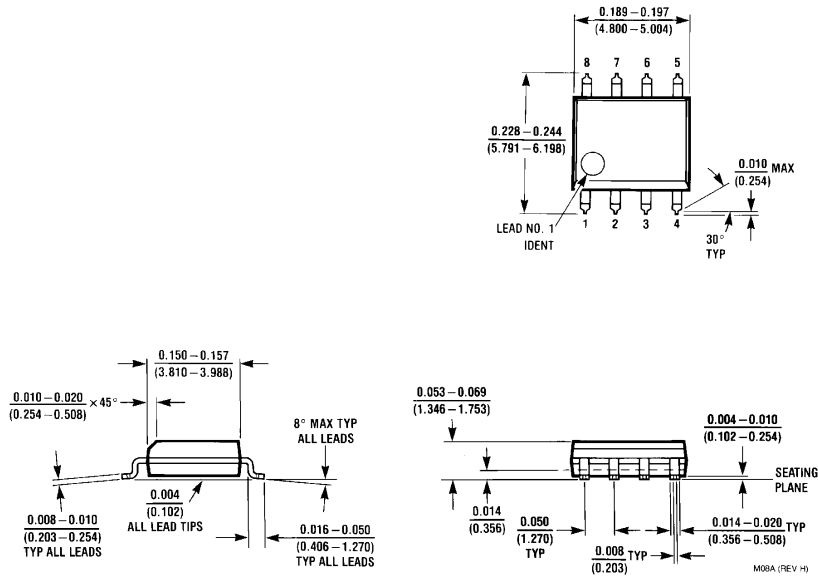
$$R_X C_X \geq (2\pi \cdot 25 \text{ MHz})^{-1}$$

$$5 R_X = R_1 + R_F(1 + R_1/R_2)$$

**Physical Dimensions** inches (millimeters) unless otherwise noted

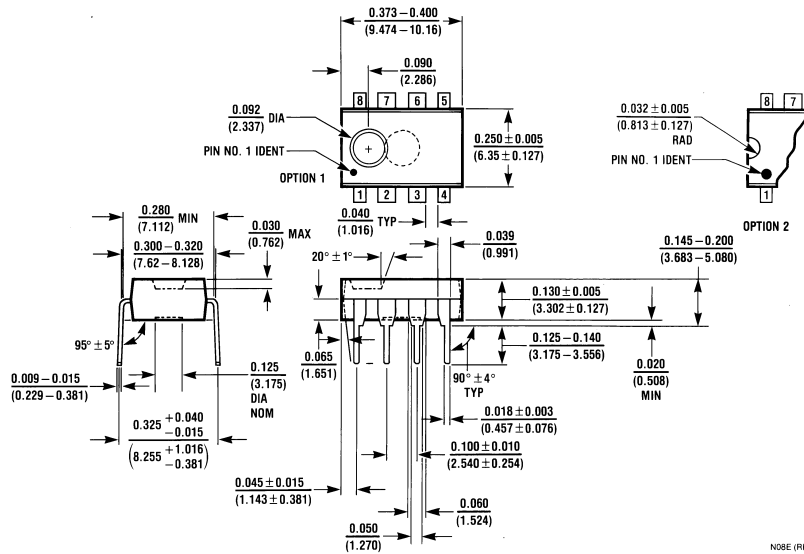


**Ceramic Dual-In-Line Package (J)**  
**Order Number LM6164J/883**  
**NS Package Number J08A**

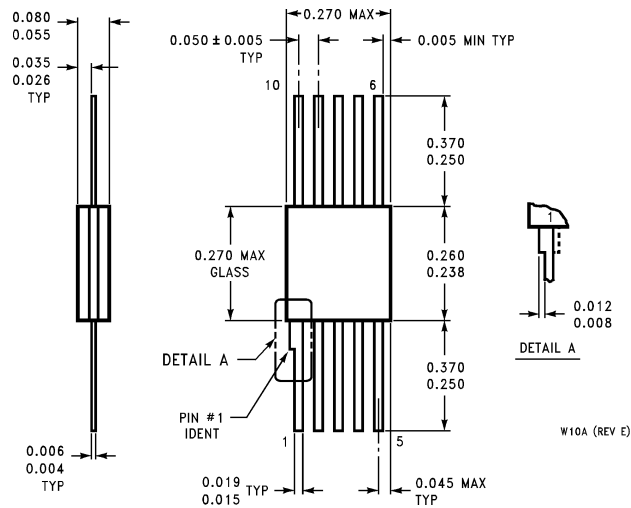


**Molded Package SO (M)**  
**Order Number LM6364M**  
**NS Package Number M08A**

**Physical Dimensions** inches (millimeters) unless otherwise noted (Continued)



**Molded Dual-In-Line Package (N)**  
**Order Number LM6264N or LM6364N**  
**NS Package Number N08E**



**10-Pin Ceramic Flatpak**  
**Order Number LM6164W/883**  
**NS Package Number W10A**

## Notes

### LIFE SUPPORT POLICY

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1. Life support devices or systems are devices or systems which, (a) are intended for surgical implant into the body, or (b) support or sustain life, and whose failure to perform when properly used in accordance with instructions for use provided in the labeling, can be reasonably expected to result in a significant injury to the user.
2. A critical component is any component of a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.



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